

$V_{DSS}$	-12V
$R_{DS(on)(Max.)}$	23mΩ
$I_D$	±6A
$P_D$	1.5W

### ●Features

- 1) Low on - resistance.
- 2) -1.5V Drive
- 3) Built-in G-S protection diode.
- 4) Small surface mount package(TSMT8).
- 5) Pb-free lead plating ; RoHS compliant

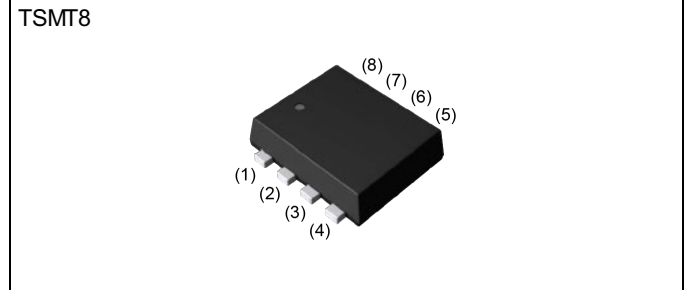
### ●Application

Switching

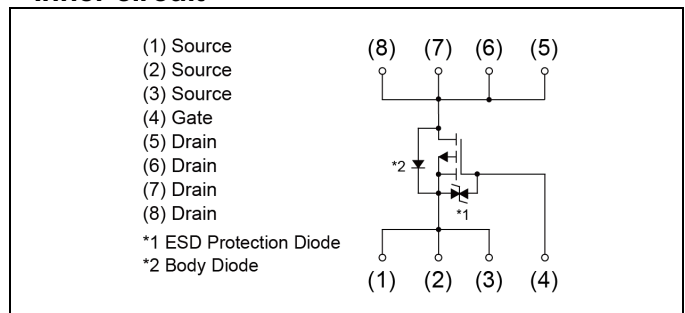
### ●Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Value	Unit
Drain - Source voltage	$V_{DSS}$	-12	V
Continuous drain current	$I_D$	±6	A
Pulsed drain current	$I_{D,pulse}^{*1}$	±24	A
Gate - Source voltage	$V_{GSS}$	±10	V
Power dissipation	$P_D^{*2}$	1.5	W
	$P_D^{*3}$	0.7	W
Junction temperature	$T_j$	150	°C
Range of storage temperature	$T_{stg}$	-55 to +150	°C

### ●Outline



### ●Inner circuit



### ●Packaging specifications

Type	Packing	Embossed Tape
	Reel size (mm)	180
	Tape width (mm)	8
	Basic ordering unit (pcs)	3000
	Taping code	TR
	Marking	YH

### ● Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - ambient	$R_{thJA}^{*2}$	-	-	83.3	°C/W
	$R_{thJA}^{*3}$	-	-	178	°C/W

### ● Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -1mA$	-12	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$I_D = -1mA$ referenced to $25^\circ\text{C}$	-	-21.9	-	mV/°C
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -12V, V_{GS} = 0V$	-	-	-1	$\mu\text{A}$
Gate - Source leakage current	$I_{GSS}$	$V_{GS} = \pm 10V, V_{DS} = 0V$	-	-	$\pm 10$	$\mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = -6V, I_D = -1mA$	-0.3	-	-1.0	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	$I_D = -1mA$ referenced to $25^\circ\text{C}$	-	2.4	-	mV/°C
Static drain - source on - state resistance	$R_{DS(on)}^{*4}$	$V_{GS} = -4.5V, I_D = -6A$	-	16	23	m $\Omega$
		$V_{GS} = -2.5V, I_D = -3A$	-	22	31	
		$V_{GS} = -1.8V, I_D = -3A$	-	28	42	
		$V_{GS} = -1.5V, I_D = -1.2A$	-	39	78	
Gate input resistance	$R_G$	$f = 1MHz, \text{open drain}$	-	20	-	$\Omega$
Forward Transfer Admittance	$ Y_{fs} ^{*4}$	$V_{DS} = -6V, I_D = -6A$	7.5	-	-	S

\*1  $P_w \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*2 Mounted on a ceramic board (30×30×0.8mm)

\*3 Mounted on a FR4 (20×20×0.8mm)

\*4 Pulsed

**●Electrical characteristics (T<sub>a</sub> = 25°C)**

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	2800	-	pF
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -6V	-	340	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	310	-	
Turn - on delay time	t <sub>d(on)</sub> <sup>*4</sup>	V <sub>DD</sub> ≈ -6V, V <sub>GS</sub> = -4.5V	-	12	-	ns
Rise time	t <sub>r</sub> <sup>*4</sup>	I <sub>D</sub> = -3A	-	105	-	
Turn - off delay time	t <sub>d(off)</sub> <sup>*4</sup>	R <sub>L</sub> ≈ 2Ω	-	400	-	
Fall time	t <sub>f</sub> <sup>*4</sup>	R <sub>G</sub> = 10Ω	-	230	-	

**●Gate charge characteristics (T<sub>a</sub> = 25°C)**

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	Q <sub>g</sub> <sup>*4</sup>	V <sub>DD</sub> ≈ -6V,	-	34	-	nC
Gate - Source charge	Q <sub>gs</sub> <sup>*4</sup>	I <sub>D</sub> = -6A,	-	6.0	-	
Gate - Drain charge	Q <sub>gd</sub> <sup>*4</sup>	V <sub>GS</sub> = -4.5V	-	5.0	-	

**●Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)**

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Body diode continuous forward current	I <sub>S</sub>	T <sub>a</sub> = 25°C	-	-	-1	A
Body diode pulse current	I <sub>SP</sub> <sup>*1</sup>		-	-	-24	A
Forward voltage	V <sub>SD</sub> <sup>*4</sup>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -6A	-	-	-1.2	V

● Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

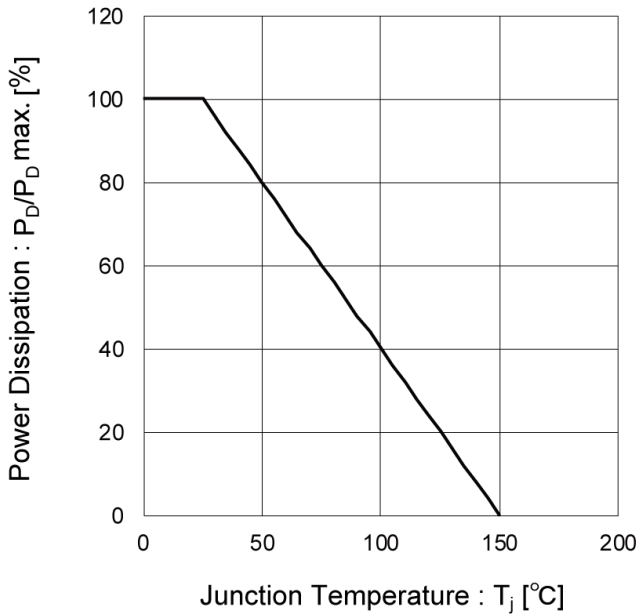


Fig.2 Maximum Safe Operating Area

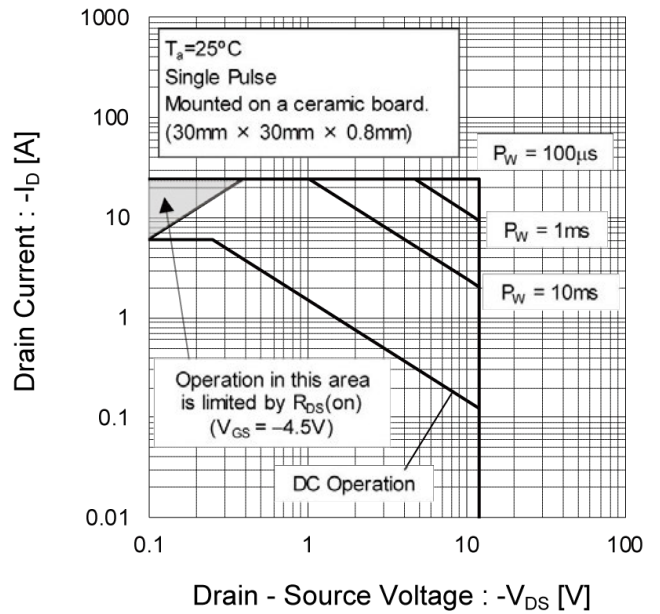


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

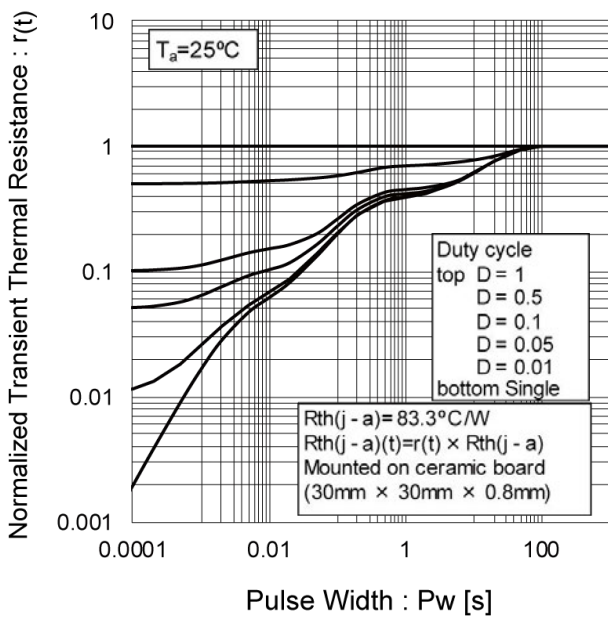
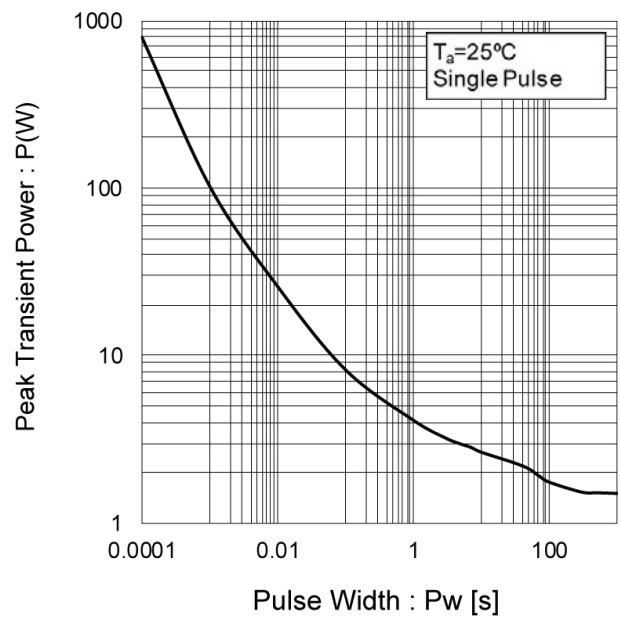


Fig.4 Single Pulse Maximum Power dissipation



● Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)

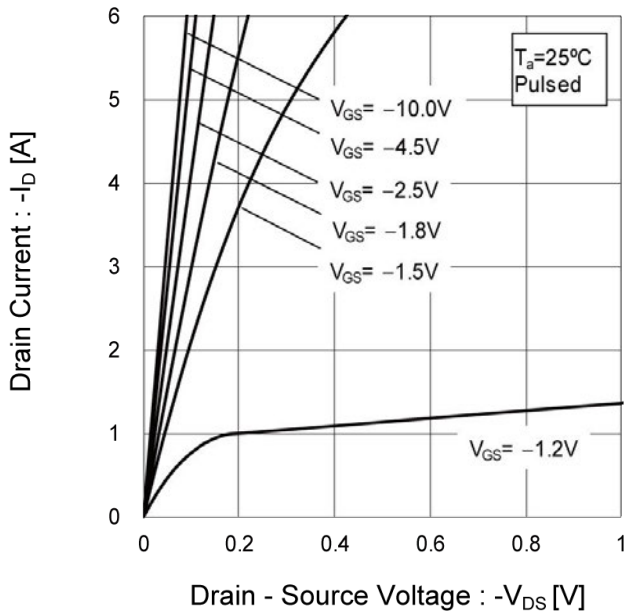


Fig.6 Typical Output Characteristics(II)

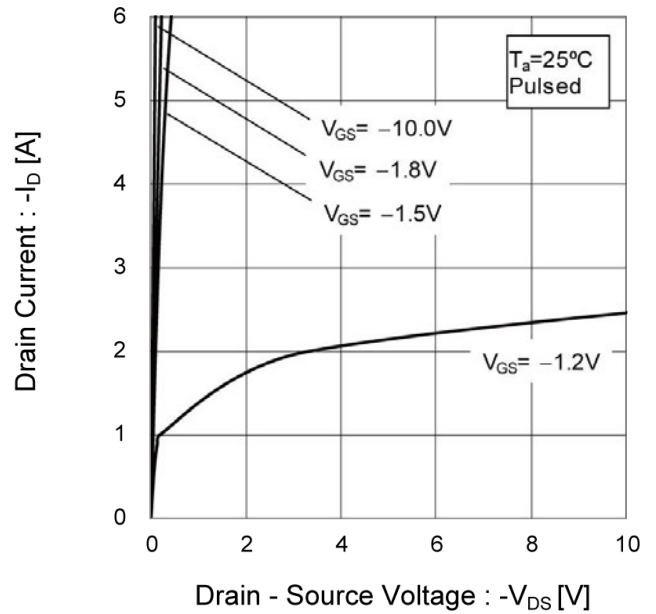


Fig.7 Breakdown Voltage vs. Junction Temperature

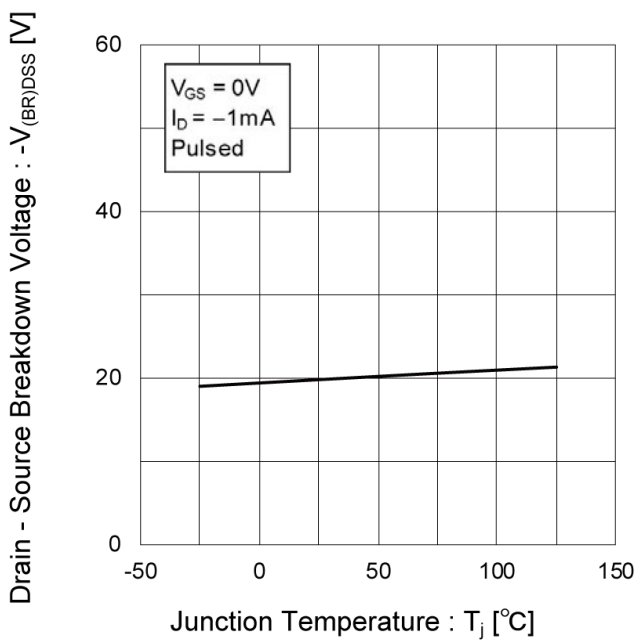
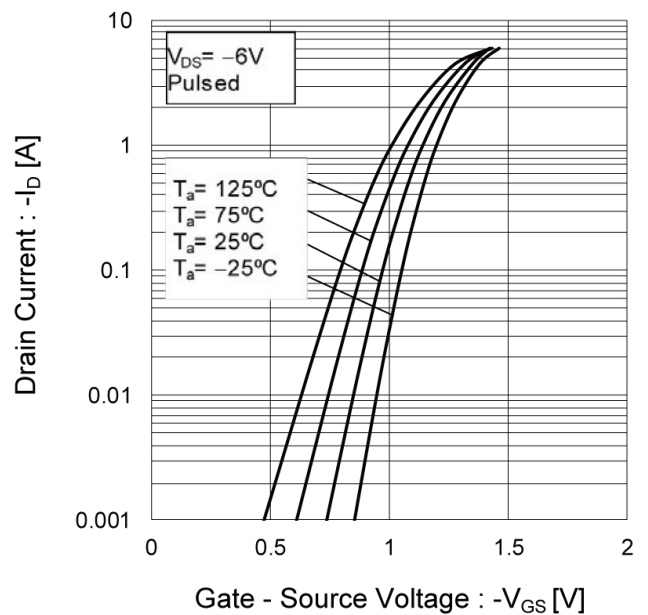


Fig.8 Typical Transfer Characteristics



● Electrical characteristic curves

Fig.9 Gate Threshold Voltage vs. Junction Temperature

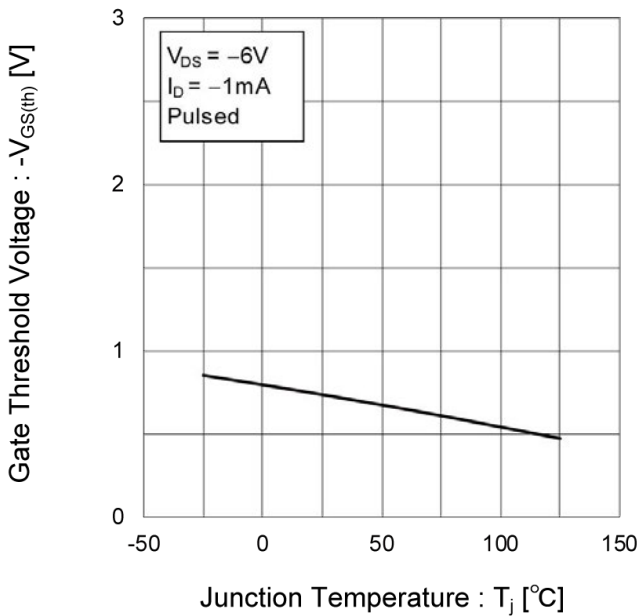


Fig.10 Forward Transfer Admittance vs. Drain Current

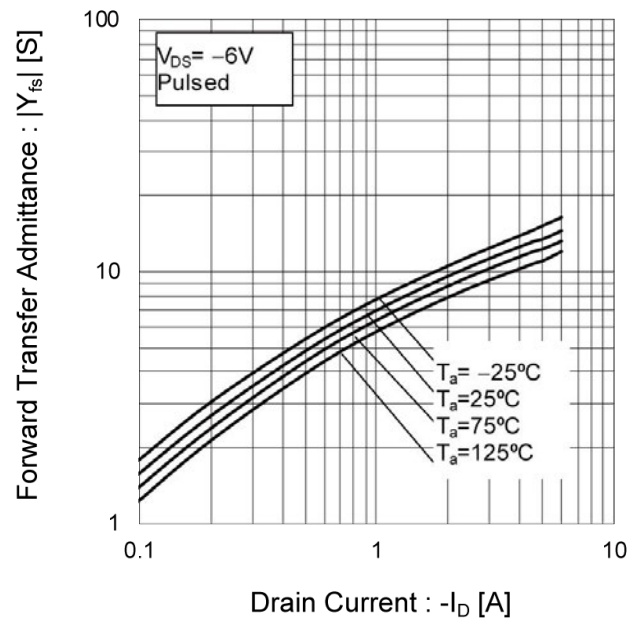


Fig.11 Drain Current Derating Curve

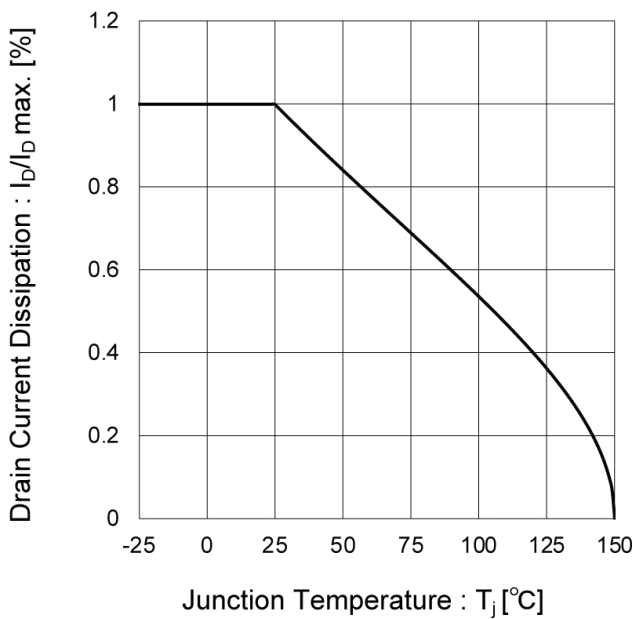
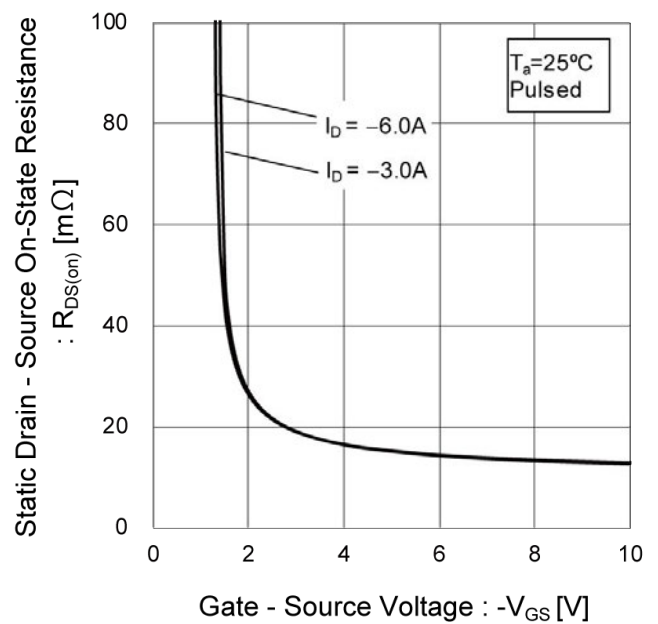


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage



● Electrical characteristic curves

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

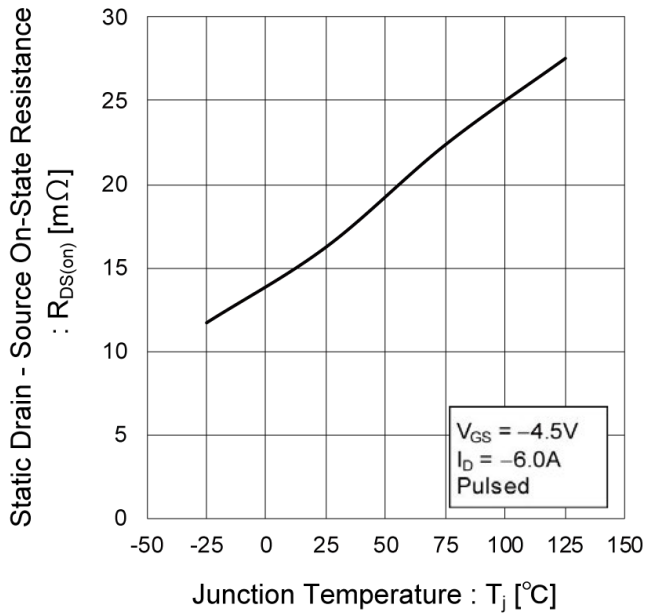
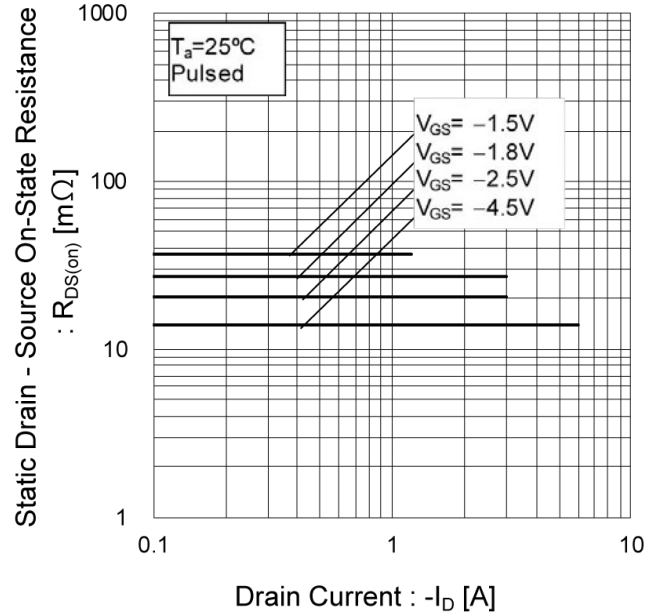


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)



● Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

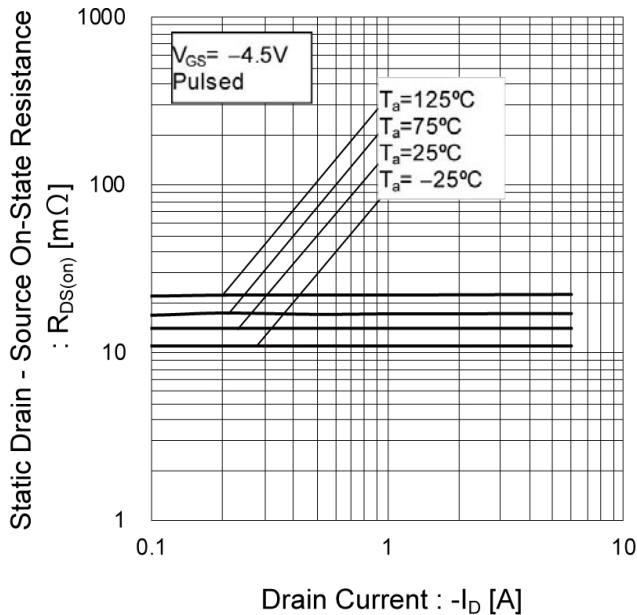


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

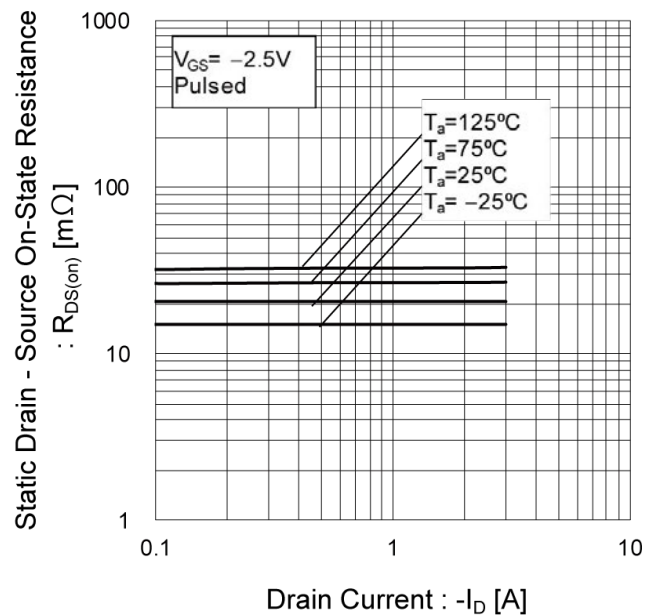


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)

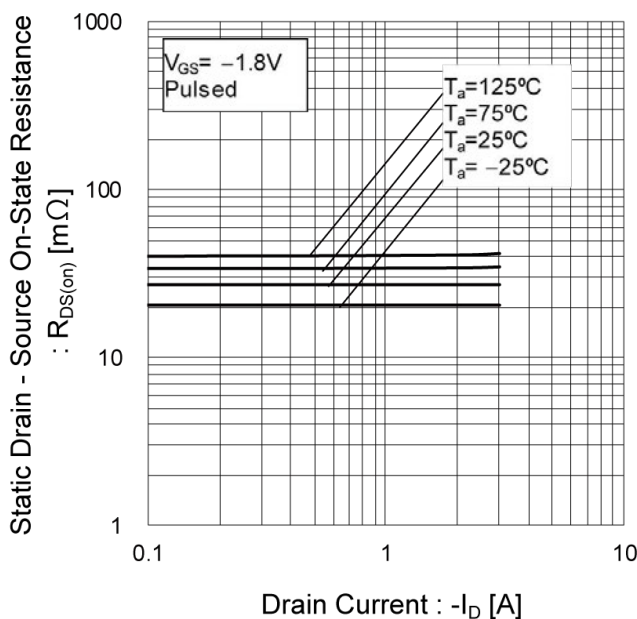
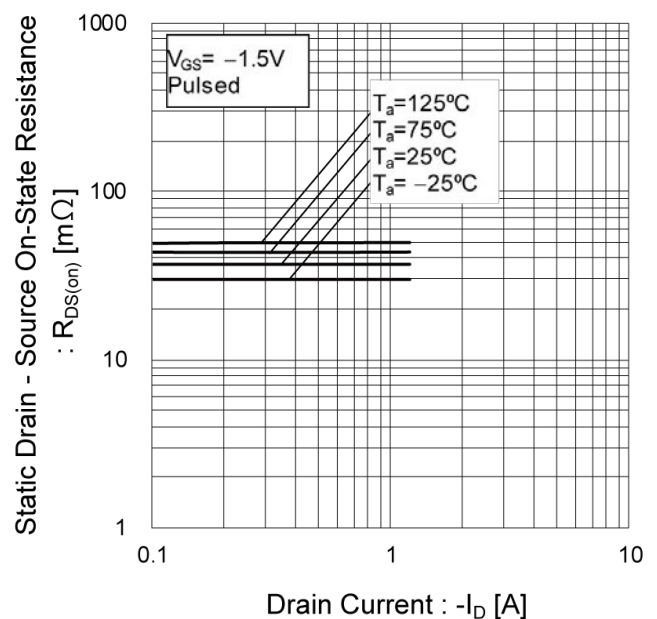


Fig.18 Static Drain - Source On - State Resistance vs. Drain Current (V)





● Electrical characteristic curves

Fig.19 Typical Capacitance vs. Drain - Source Voltage

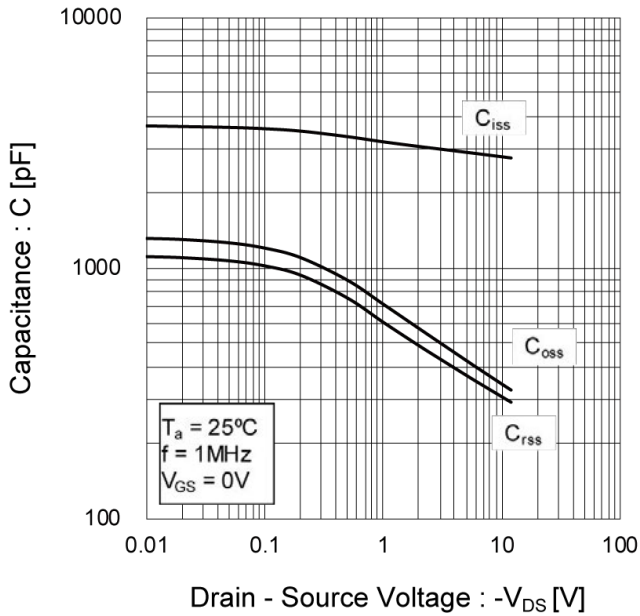


Fig.20 Switching Characteristics

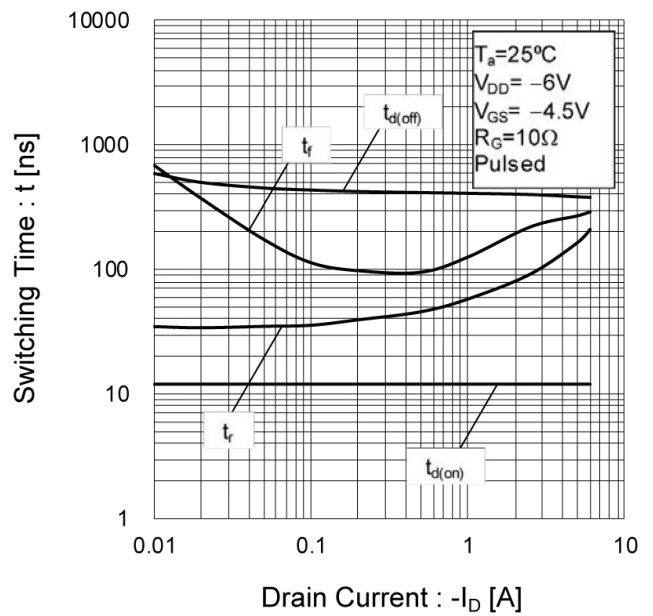


Fig.21 Dynamic Input Characteristics

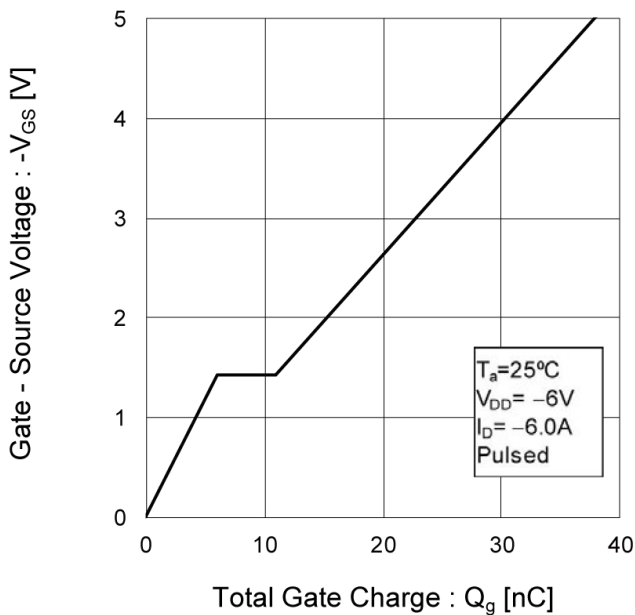
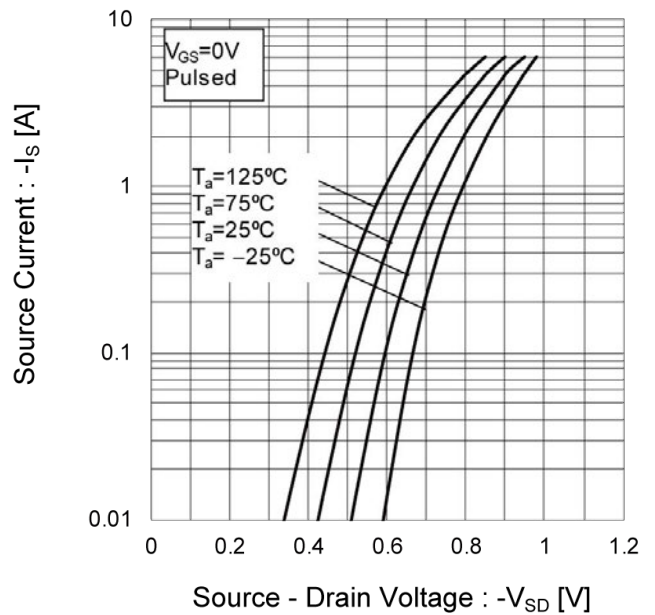


Fig.22 Source Current vs. Source Drain Voltage



● Measurement circuits

Fig. 1-1 SWITCHING TIME MEASUREMENT CIRCUIT

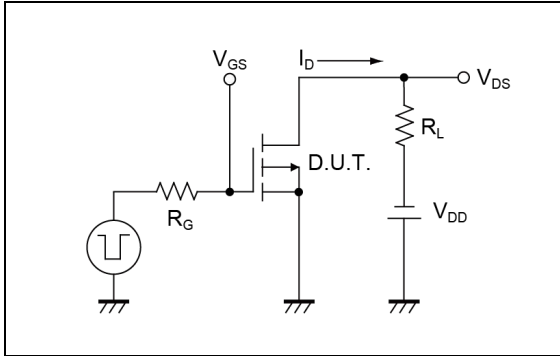


Fig. 1-2 SWITCHING WAVEFORMS

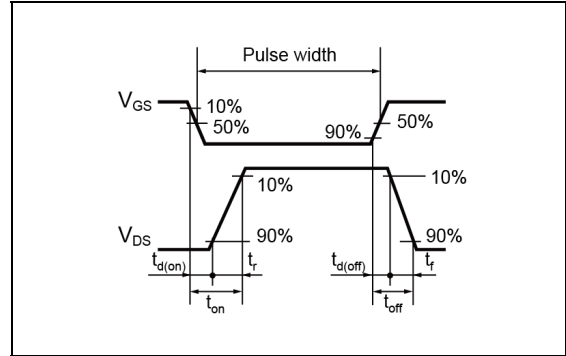


Fig. 2-1 GATE CHARGE MEASUREMENT CIRCUIT

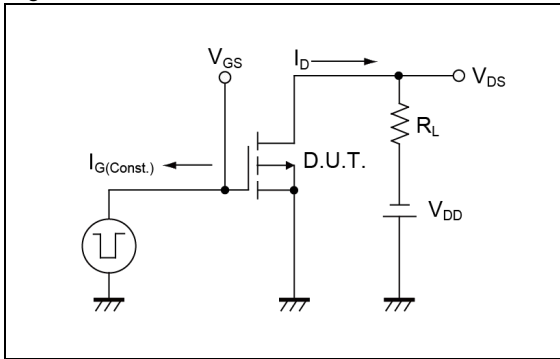
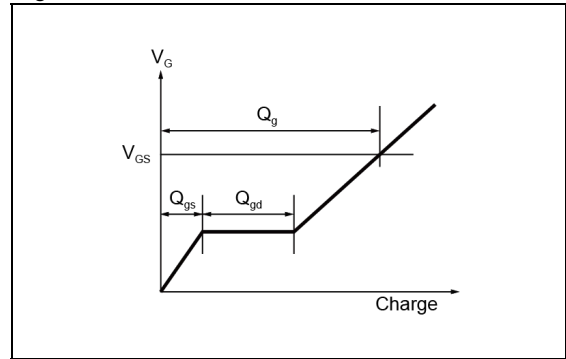


Fig. 2-2 GATE CHARGE WAVEFORM

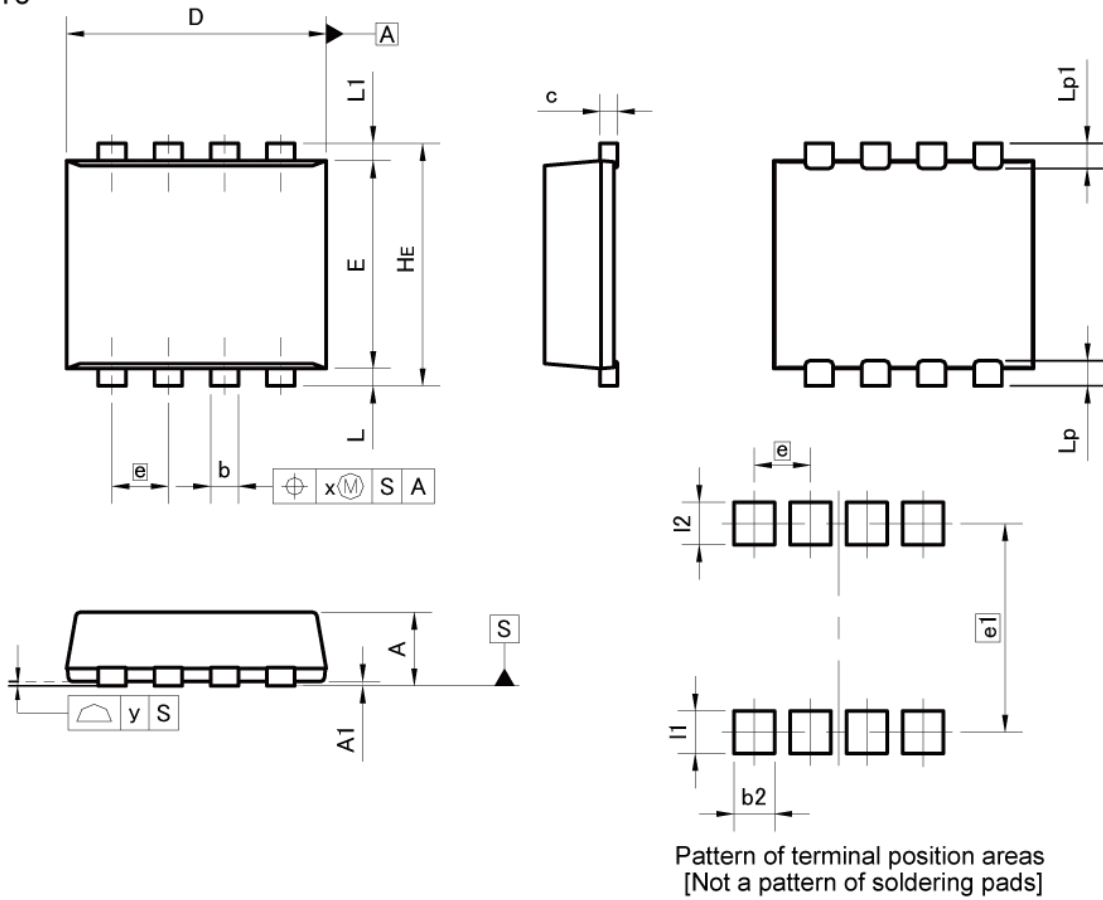


● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

●Dimensions

TSMT8



DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.75	0.85	0.030	0.033
A1	0.00	0.05	0.000	0.002
b	0.27	0.37	0.011	0.015
c	0.12	0.22	0.005	0.009
D	2.90	3.10	0.114	0.122
E	2.30	2.50	0.091	0.098
e	0.65		0.026	
HE	2.70	2.90	0.106	0.114
L	0.10	0.30	0.004	0.012
L1	0.10	0.30	0.004	0.012
Lp	0.19	0.39	0.007	0.015
Lp1	0.19	0.39	0.007	0.015
x	-	0.10	-	0.004
y	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.47	-	0.019
e1	2.41		0.095	
I1	-	0.49	-	0.019
I2	-	0.49	-	0.019

Dimension in mm/inches

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